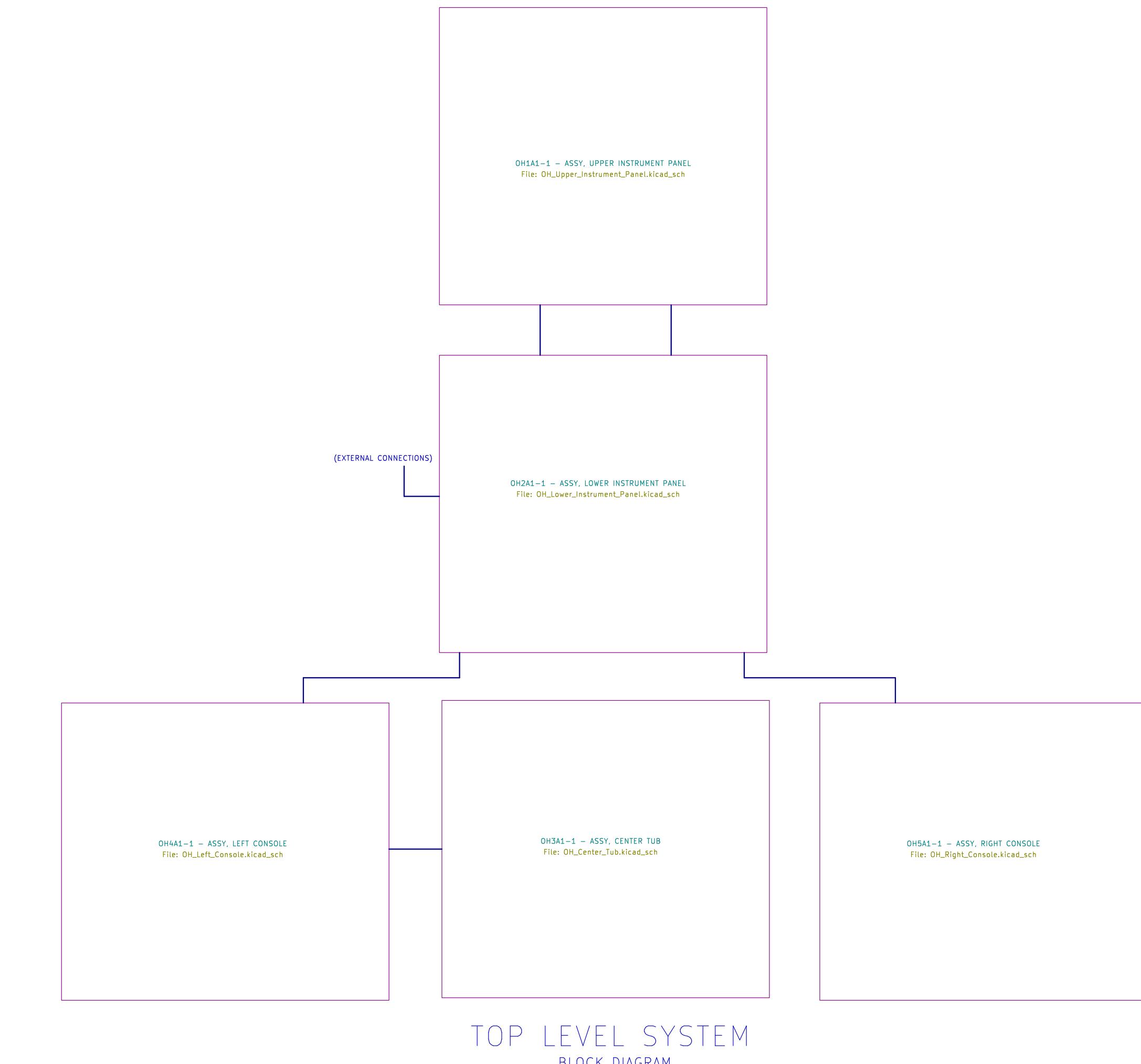


NOTES: (UNLESS OTHERWISE SPECIFIED)

- SEE OH-PL-INTERCONNECT FOR SEPARATE INTERCONNECT PARTS LIST.
- SEE OH-SPEC-002 FOR ABSIS CABLE SPECIFICATIONS.
- ALL CONDUCTORS SHALL BE WHITE STRANDED/BRAIDED INSULATED WIRES OF 26AWG FOR ALL POWER CONNECTIONS, AND 28AWG FOR ALL SIGNAL/DATA CONNECTIONS.
- CABLE COLOR SCHEMES MAY BE ALTERED TO IDENTIFY CONDUCTOR FUNCTION. IF A DIFFERENT CABLE COLOR SCHEME IS USED, DOCUMENT COLOR SCHEME AS APPROPRIATE.
- TERMINATE ALL UNUSED CONDUCTORS BY FOLDING BACK CONDUCTORS AND HEAT SHRINKING CONDUCTOR ALONG CABLE.
- INSTALL USB 3.0 PCIE CARD INTO HOST PC. USE MOTHERBOARD-BASED USB PORTS AT OWN RISK.



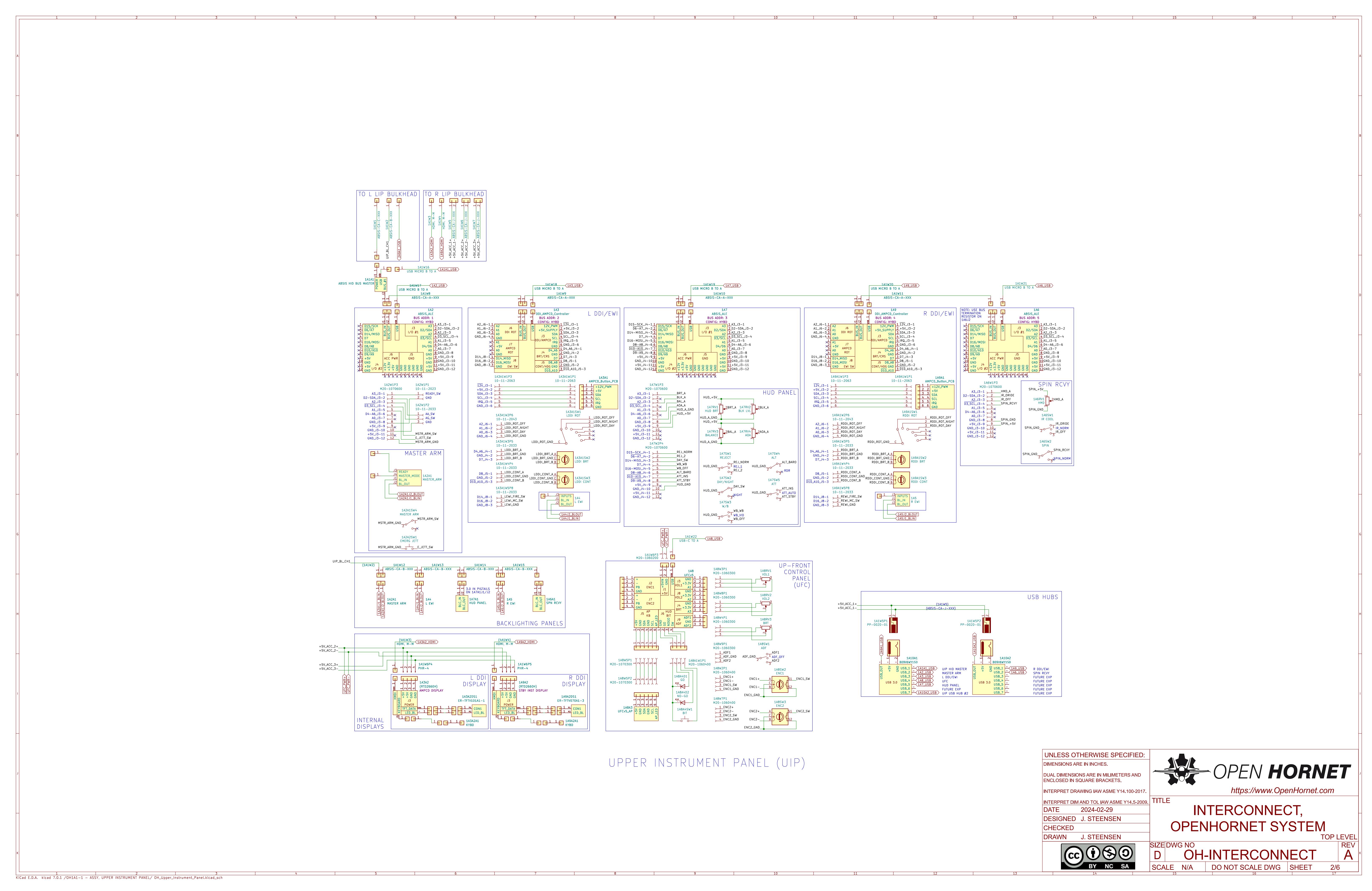
UNLESS OTHERWISE SPECIFIED: DIMENSIONS ARE IN INCHES. DUAL DIMENSIONS ARE IN MILLIMETERS AND ENCLOSED IN SQUARE BRACKETS.	
INTERPRET DRAWING IAW ASME Y14.100-2017.	
INTERPRET DIM AND TOL IAW ASME Y14.5-2009.	
DATE 2024-02-29	
DESIGNED J. STEENSEN	
CHECKED	
DRAWN J. STEENSEN	
SIZE DWG NO D OH-INTERCONNECT REV A	
SCALE N/A DO NOT SCALE DWG SHEET 1/6	

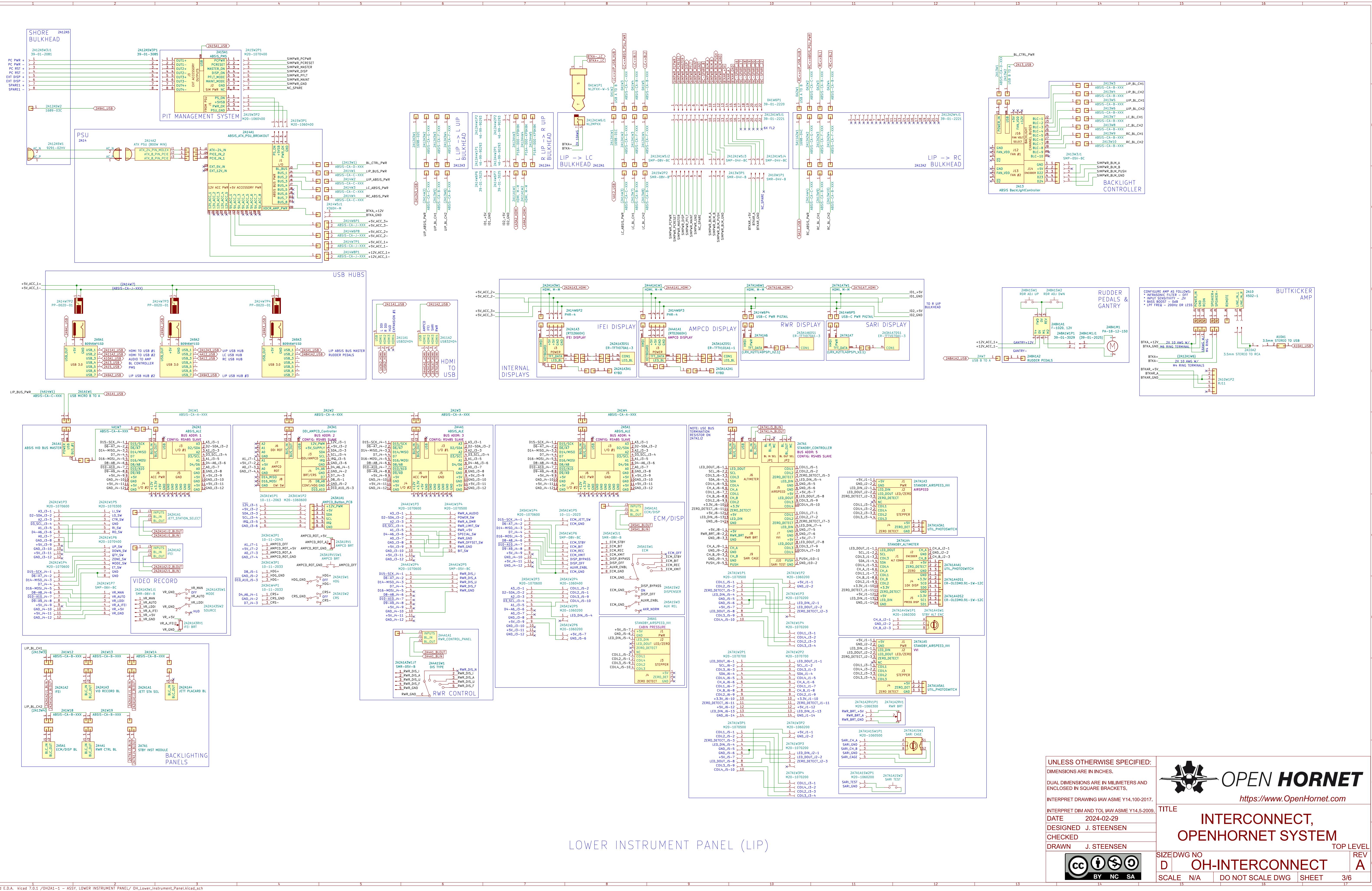


<https://www.OpenHornet.com>

INTERCONNECT, OPENHORNET SYSTEM

TOP LEVEL





LOWER INSTRUMENT PANEL (LIP)

UNLESS OTHERWISE SPECIFIED:
DIMENSIONS ARE IN INCHES.
DUAL DIMENSIONS ARE IN MILLIMETERS AND ENCLOSED IN SQUARE BRACKETS.

OPEN HORNET
<https://www.OpenHornet.com>

TITLE
INTERCONNECT,
OPENHORNET SYSTEM

TOP LEVEL

SIZE DWG NO D OH-INTERCONNECT

REV A

SCALE N/A DO NOT SCALE DWG SHEET 3/6

CC BY NC SA

K

1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17

KICad E.D.A. kicad 7.0.1 /OH2A1-1 - ASSY, LOWER INSTRUMENT PANEL / OH_Lower_Instrument_Panel.kicad_sch

